

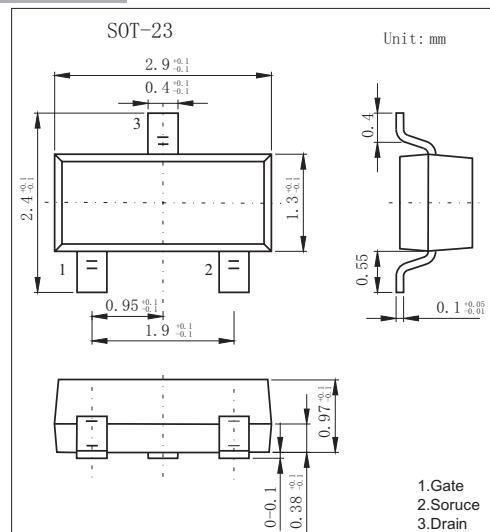
## SOT-23 Plastic-Encapsulate MOSFETS

### Features

- N-Channel Enhancement MOSFET
- Low On-Resistance: RDS(ON) Low Gate Threshold Voltage
- Low Input Capacitance Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected 2KV HBM

### MECHANICAL DATA

- Case style:SOT-23molded plastic
- Mounting position:any



### MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	60	V
Gate-Source Voltage -Continuous	V <sub>Gs</sub>	±20	
Drain Current -Continuous ( Note:1) -Pulsed	I <sub>D</sub>	300	mA
		800	
Power Dissipation (Note 1)	P <sub>D</sub>	350	mW
Thermal Resistance.Junction- to-Ambient	R <sub>thJA</sub>	357	°C/W
Junction Temperature	T <sub>J</sub>	150	°C
Junction and Storage Temperature Range	T <sub>stg</sub>	-55 to 150	

Notes: 1. Device mounted on FR-4 PCB.

### Mosfet Electrical Characteristics T<sub>A</sub>=25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage (Note.2)	V <sub>DSS</sub>	I <sub>D</sub> =100 μA, V <sub>Gs</sub> =0V	60			V
Zero Gate Voltage Drain Current (Note.2)	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>Gs</sub> =0V			1	μA
Gate-Body Leakage Current (Note.2)	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>Gs</sub> =±20V			±10	uA
Gate Threshold Voltage (Note.2)	V <sub>Gs(th)</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA	1	1.6	2.5	V
Static Drain-Source On-Resistance (Note.2)	R <sub>ds(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =500mA			2	Ω
		V <sub>GS</sub> =10V, I <sub>D</sub> =50mA			3	
Forward Transfer Admittance (Note.2)	Y <sub>fs</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =200mA	80			ms
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz			50	pF
Output Capacitance	C <sub>oss</sub>				25	
Reverse Transfer Capacitance	C <sub>rss</sub>				5	
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =15V, I <sub>D</sub> =200mA			0.8	nC
Turn-On DelayTime	t <sub>d(on)</sub>	I <sub>D</sub> =200mA, V <sub>DS</sub> =30V, R <sub>G</sub> =10Ω, V <sub>GEN</sub> =10V, R <sub>L</sub> =150Ω			20	ns
Turn-Off DelayTime	t <sub>d(off)</sub>				40	

Note: 2. Short duration test pulse used to minimize self-heating effect.

### Marking

Marking	K72	72K
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# RATINGS AND CHARACTERISTIC CURVES

## ■ Typical Characteristics

